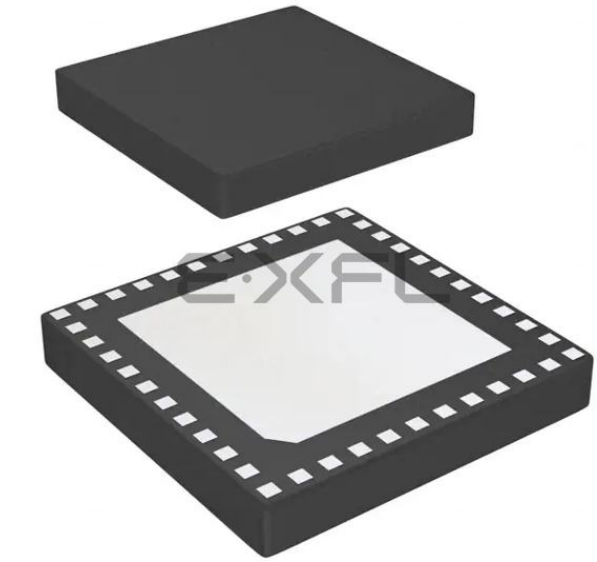
Microchip Technology - DSPIC33FJ16GS504-E/TL Datasheet



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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	dsPIC
Core Size	16-Bit
Speed	40 MIPs
Connectivity	I²C, IrDA, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	35
Program Memory Size	16KB (16K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 3.6V
Data Converters	A/D 24x10b; D/A 4x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	44-VFTLA Exposed Pad
Supplier Device Package	44-VTLA (6x6)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/dspic33fj16gs504-e-tl

Referenced Sources

This device data sheet is based on the following individual chapters of the *"dsPIC33/PIC24 Family Reference Manual"*. These documents should be considered as the primary reference for the operation of a particular module or device feature.

Note: To access the documents listed below, browse to the documentation section of the dsPIC33FJ16GS504 product page of the Microchip web site (www.microchip.com).

In addition to parameters, features, and other documentation, the resulting page provides links to the related family reference manual sections.

- **"Introduction"** (DS70197)
- **"CPU"** (DS70204)
- **"Data Memory"** (DS70202)
- **"Program Memory"** (DS70203)
- **"Flash Programming"** (DS70191)
- **"Reset"** (DS70192)
- **"Watchdog Timer (WDT) and Power-Saving Modes"** (DS70196)
- **"I/O Ports"** (DS70193)
- **"Timers"** (DS70205)
- **"Input Capture"** (DS70198)
- **"Output Compare"** (DS70005157)
- **"Analog-to-Digital Converter (ADC)"** (DS70621)
- **"UART"** (DS70188)
- **"Serial Peripheral Interface (SPI)"** (DS70206)
- **"Inter-Integrated Circuit™ (I^2C™)"** (DS70000195)
- **"CodeGuard™ Security** (DS70199)
- **"Programming and Diagnostics"** (DS70207)
- **"Device Configuration"** (DS70194)
- **"Interrupts (Part IV)"** (DS70300)
- **"Oscillator (Part IV)"** (DS70307)
- **"High- Speed PWM Module"** (DS70000323)
- **"High-Speed 10-Bit ADC"** (DS70000321)
- **"High-Speed Analog Comparator"** (DS70296)
- **"Oscillator (Part VI)"** (DS70644)

REGISTER 3-1: SR: CPU STATUS REGISTER (CONTINUED)

bit 7-5 **IPL<2:0>:** CPU Interrupt Priority Level Status bits(2,3)

111 = CPU Interrupt Priority Level is 7 (15), user interrupts disabled
110 = CPU Interrupt Priority Level is 6 (14)
101 = CPU Interrupt Priority Level is 5 (13)
100 = CPU Interrupt Priority Level is 4 (12)
011 = CPU Interrupt Priority Level is 3 (11)
010 = CPU Interrupt Priority Level is 2 (10)
001 = CPU Interrupt Priority Level is 1 (9)
000 = CPU Interrupt Priority Level is 0 (8)

bit 4 **RA:** REPEAT Loop Active bit

1 = REPEAT loop in progress
0 = REPEAT loop not in progress

bit 3 **N:** MCU ALU Negative bit

1 = Result was negative
0 = Result was non-negative (zero or positive)

bit 2 **OV:** MCU ALU Overflow bit

This bit is used for signed arithmetic (2's complement). It indicates an overflow of a magnitude that causes the sign bit to change state.
1 = Overflow occurred for signed arithmetic (in this arithmetic operation)
0 = No overflow occurred

bit 1 **Z:** MCU ALU Zero bit

1 = An operation that affects the Z bit has set it at some time in the past
0 = The most recent operation that affects the Z bit has cleared it (i.e., a non-zero result)

bit 0 **C:** MCU ALU Carry/$\overline{\text{Borrow}}$ bit

1 = A carry-out from the Most Significant bit (MSb) of the result occurred
0 = No carry-out from the Most Significant bit of the result occurred

Note 1: This bit can be read or cleared (not set).

2: The IPL<2:0> bits are concatenated with the IPL<3> bit (CORCON<3>) to form the CPU Interrupt Priority Level (IPL). The value in parentheses indicates the IPL if IPL<3> = 1. User interrupts are disabled when IPL<3> = 1.

3: The IPL<2:0> Status bits are read-only when NSTDIS = 1 (INTCON1<15>).

4: Clearing this bit will clear SA and SB.

TABLE 4-9: INTERRUPT CONTROLLER REGISTER MAP FOR dsPIC33FJ16GS502 DEVICES ONLY

File Name	SFR Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
INTCON1	0080	NSTDIS	OVAERR	OVBERR	COVAERR	COVBERR	OVATE	OVBTE	COVTE	SFTACERR	DIV0ERR	—	MATHERR	ADDRERR	STKERR	OSCFAIL	—	0000
INTCON2	0082	ALTIVT	DISI	—	—	—	—	—	—	—	—	—	—	—	INT2EP	INT1EP	INT0EP	0000
IFS0	0084	—	—	ADIF	U1TXIF	U1RXIF	SPI1IF	SPI1EIF	T3IF	T2IF	OC2IF	IC2IF	—	T1IF	OC1IF	IC1IF	INT0IF	0000
IFS1	0086	—	—	INT2IF	—	—	—	—	—	—	—	—	INT1IF	CNIF	AC1IF	MI2C1IF	SI2C1IF	0000
IFS3	008A	—	—	—	—	—	—	PSEMIF	—	—	—	—	—	—	—	—	—	0000
IFS4	008C	—	—	—	—	—	—	—	—	—	—	—	—	—	—	U1EIF	—	0000
IFS5	008E	PWM2IF	PWM1IF	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
IFS6	0090	ADCP1IF	ADCP0IF	—	—	—	—	AC4IF	AC3IF	AC2IF	—	—	—	—	—	PWM4IF	PWM3IF	0000
IFS7	0092	—	—	—	—	—	—	—	—	—	—	—	ADCP6IF	—	—	ADCP3IF	ADCP2IF	0000
IEC0	0094	—	—	ADIE	U1TXIE	U1RXIE	SPI1IE	SPI1EIE	T3IE	T2IE	OC2IE	IC2IE	—	T1IE	OC1IE	IC1IE	INT0IE	0000
IEC1	0096	—	—	INT2IE	—	—	—	—	—	—	—	—	INT1IE	CNIE	AC1IE	MI2C1IE	SI2C1IE	0000
IEC3	009A	—	—	—	—	—	—	PSEMIE	—	—	—	—	—	—	—	—	—	0000
IEC4	009C	—	—	—	—	—	—	—	—	—	—	—	—	—	—	U1EIE	—	0000
IEC5	009E	PWM2IE	PWM1IE	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
IEC6	00A0	ADCP1IE	ADCP0IE	—	—	—	—	AC4IE	AC3IE	AC2IE	—	—	—	—	—	PWM4IE	PWM3IE	0000
IEC7	00A2	—	—	—	—	—	—	—	—	—	—	—	ADCP6IE	—	—	ADCP3IE	ADCP2IE	0000
IPC0	00A4	—	T1IP2	T1IP1	T1IP0	—	OC1IP2	OC1IP1	OC1IP0	—	IC1IP2	IC1IP1	IC1IP0	—	INT0IP2	INT0IP1	INT0IP2	4444
IPC1	00A6	—	T2IP2	T2IP1	T2IP0	—	OC2IP2	OC2IP1	OC2IP0	—	IC2IP2	IC2IP1	IC2IP0	-—	—	—	—	4440
IPC2	00A8	—	U1RXIP2	U1RXIP1	U1RXIP0	—	SPI1IP2	SPI1IP1	SPI1IP0	—	SPI1EIP2	SPI1EIP1	SPI1EIP0	—	T3IP2	T3IP1	T3IP0	4444
IPC3	00AA	—	—	—	—	—	—	—	—	—	ADIP2	ADIP1	ADIP0	—	U1TXIP2	U1TXIP1	U1TXIP0	0044
IPC4	00AC	—	CNIP2	CNIP1	CNIP0	—	AC1IP2	AC1IP1	AC1IP0	—	MI2C1IP2	MI2C1IP1	MI2C1IP0	—	SI2C1IP2	SI2C1IP1	SI2C1IP0	4444
IPC5	00AE	—	—	—	—	—	—	—	—	—	—	—	—	—	INT1IP2	INT1IP1	INT1IP0	0004
IPC7	00B2	—	—	—	—	—	—	—	—	—	INT2IP2	INT2IP1	INT2IP0	—	—	—	—	0040
IPC14	00C0	—	—	—	—	—	—	—	—	—	PSEMIP2	PSEMIP1	PSEMIP0	—	—	—	—	0040
IPC16	00C4	—	—	—	—	—	—	—	—	—	U1EIP2	U1EIP1	U1EIP0	—	—	—	—	0040
IPC23	00D2	—	PWM2IP2	PWM2IP1	PWM2IP0	—	PWM1IP2	PWM1IP1	PWM1IP0	—	—	—	—	—	—	—	—	4400
IPC24	00D4	—	—	—	—	—	—	—	—	—	PWM4IP2	PWM4IP1	PWM4IP0	—	PWM3IP2	PWM3IP1	PWM3IP0	0044
IPC25	00D6	—	AC2IP2	AC2IP1	AC2IP0	—	—	—	—	—	—	—	—	—	—	—	—	4000
IPC26	00D8	—	—	—	—	—	—	—	—	—	AC4IP2	AC4IP1	AC4IP0	—	AC3IP2	AC3IP1	AC3IP0	0044
IPC27	00DA	—	ADCP1IP2	ADCP1IP1	ADCP1IP0	—	ADCP0IP2	ADCP0IP1	ADCP0IP0	——	—	—	—	—	—	—	—	4400
IPC28	00DC	—	—	—	—	—	—	—	—	—	ADCP3IP2	ADCP3IP1	ADCP3IP0	—	ADCP2IP2	ADCP2IP1	ADCP2IP0	0044
IPC29	00DE	—	—	—	—	—	—	—	—	—	—	—	—	—	ADCP6IP2	ADCP6IP1	ADCP6IP0	0004
INTTREG	00E0	—	—	—	—	ILR3	ILR2	ILR1	ILR0	—	VECNUM6	VECNUM5	VECNUM4	VECNUM3	VECNUM2	VECNUM1	VECNUM0	0000

Legend: x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 4-37: PORTA REGISTER MAP

File Name	SFR Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
TRISA	02C0	—	—	—	—	—	—	—	—	—	—	—	TRISA<4:0>					001F
PORTA	02C2	—	—	—	—	—	—	—	—	—	—	—	RA<4:0>					xxxx
LATA	02C4	—	—	—	—	—	—	—	—	—	—	—	LATA<4:0>					0000
ODCA	02C6	—	—	—	—	—	—	—	—	—	—	—	ODCA<4:3>		—	—	—	0000

Legend: x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 4-38: PORTB REGISTER MAP FOR dsPIC33FJ06GS101

File Name	SFR Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
TRISB	02C8	—	—	—	—	—	—	—	—	TRISB<7:0>								00FF
PORTB	02CA	—	—	—	—	—	—	—	—	RB<7:0>								xxxx
LATB	02CC	—	—	—	—	—	—	—	—	LATB<7:0>								0000
ODCB	02CE	—	—	—	—	—	—	—	—	ODCB<7:6>		—	ODCB4	—	—	—	—	0000

Legend: x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 4-39: PORTB REGISTER MAP FOR dsPIC33FJ06GS102, dsPIC33FJ06GS202, dsPIC33FJ16GS402, dsPIC33FJ16GS404, dsPIC33FJ16GS502 AND dsPIC33FJ16GS504

File Name	SFR Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
TRISB	02C8	TRISB<15:0>																FFFF
PORTB	02CA	RB<15:0>																xxxx
LATB	02CC	LATB<15:0>																0000
ODCB	02CE	ODCB<15:11>					—	—	ODCB<8:6>			—	ODCB4(1)	—	—	—	—	0000

Legend: x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.
Note 1: This bit is not available on dsPIC33FJ06GS202/502 devices.

TABLE 4-40: PORTC REGISTER MAP FOR dsPIC33FJ16GS404 AND dsPIC33FJ16GS504

SFR Name	SFR Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
TRISC	02D0	—	—	TRISC<13:0>														3FFF
PORTC	02D2	—	—	RC<13:0>														xxxx
LATC	02D4	—	—	LATC<13:0>														0000
ODCC	02D6	—	—	ODCC<13:11>			—	—	ODCC<8:3>						—	—	ODCC0	0000

Legend: x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 4-41: SYSTEM CONTROL REGISTER MAP

File Name	SFR Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
RCON	0740	TRAPR	IOPUWR	—	—	—	—	CM	VREGS	EXTR	SWR	SWDTEN	WDTO	SLEEP	IDLE	BOR	POR	xxxx(1)
OSCCON	0742	—	COSC2	COSC1	COSC0	—	NOSC2	NOSC1	NOSC0	CLKLOCK	IOLOCK	LOCK	—	CF	—	—	OSWEN	0300(2)
CLKDIV	0744	ROI	DOZE2	DOZE1	DOZE0	DOZEN	FRCDIV2	FRCDIV1	FRCDIV0	PLLPOST1	PLLPOST0	—	PLLPRE4	PLLPRE3	PLLPRE2	PLLPRE1	PLLPRE0	3040
PLLFBD	0746	—	—	—	—	—	—	—	PLLDIV<8:0>									0030
REFOCON	074E	ROON	—	ROSSLP	ROSEL	RODIV3	RODIV2	RODIV1	RODIV0	—	—	—	—	—	—	—	—	0000
OSCTUN	0748	—	—	—	—	—	—	—	—	—	—	TUN<5:0>						0000
ACLKCON	0750	ENAPLL	APLLCK	SELACLK	—	—	APSTSCLR2	APSTSCLR1	APSTSCLR0	ASRCSEL	FRCSEL	—	—	—	—	—	—	2300

Legend: x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.
Note 1: The RCON register Reset values are dependent on the type of Reset.
2: The OSCCON register Reset values are dependent on the FOSCx Configuration bits and on type of Reset.

TABLE 4-42: NVM REGISTER MAP

File Name	SFR Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
NVMCON	0760	WR	WREN	WRERR	—	—	—	—	—	—	ERASE	—	—	NVMOP3	NVMOP2	NVMOP1	NVMOP0	0000(1)
NVMKEY	0766	—	—	—	—	—	—	—	—	NVMKEY<7:0>								0000

Legend: x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.
Note 1: Reset value shown is for POR only. The value on other Reset states is dependent on the state of memory write or erase operations at the time of Reset.

TABLE 4-43: PMD REGISTER MAP FOR dsPIC33FJ06GS101 DEVICES ONLY

File Name	SFR Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
PMD1	0770	—	—	—	T2MD	T1MD	—	PWMMD	—	I2C1MD	—	U1MD	—	SPI1MD	—	—	ADCMD	0000
PMD2	0772	—	—	—	—	—	—	IC2MD	IC1MD	—	—	—	—	—	—	OC2MD	OC1MD	0000
PMD3	0774	—	—	—	—	—	CMPMD	—	—	—	—	—	—	—	—	—	—	0000
PMD4	0776	—	—	—	—	—	—	—	—	—	—	—	—	REFOMD	—	—	—	0000
PMD6	077A	—	—	—	—	PWM4MD	—	—	PWM1MD	—	—	—	—	—	—	—	—	0000

Legend: x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 4-44: PMD REGISTER MAP FOR dsPIC33FJ06GS102 DEVICES ONLY

File Name	SFR Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
PMD1	0770	—	—	—	T2MD	T1MD	—	PWMMD	—	I2C1MD	—	U1MD	—	SPI1MD	—	—	ADCMD	0000
PMD2	0772	—	—	—	—	—	—	IC2MD	IC1MD	—	—	—	—	—	—	OC2MD	OC1MD	0000
PMD3	0774	—	—	—	—	—	CMPMD	—	—	—	—	—	—	—	—	—	—	0000
PMD4	0776	—	—	—	—	—	—	—	—	—	—	—	—	REFOMD	—	—	—	0000
PMD6	077A	—	—	—	—	—	—	PWM2MD	PWM1MD	—	—	—	—	—	—	—	—	0000

Legend: x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 4-48: FUNDAMENTAL ADDRESSING MODES SUPPORTED

Addressing Mode	Description
File Register Direct	The address of the file register is specified explicitly.
Register Direct	The contents of a register are accessed directly.
Register Indirect	The contents of Wn forms the Effective Address (EA).
Register Indirect Post-Modified	The contents of Wn forms the EA. Wn is post-modified (incremented or decremented) by a constant value.
Register Indirect Pre-Modified	Wn is pre-modified (incremented or decremented) by a signed constant value to form the EA.
Register Indirect with Register Offset (Register Indexed)	The sum of Wn and Wb forms the EA.
Register Indirect with Literal Offset	The sum of Wn and a literal forms the EA.

4.3.3 MOVE AND ACCUMULATOR INSTRUCTIONS

Move instructions and the DSP accumulator class of instructions to provide a greater addressing flexibility than other instructions. In addition to the addressing modes supported by most MCU instructions, move and accumulator instructions also support Register Indirect with Register Offset Addressing mode, also referred to as Register Indexed mode.

Note: For the MOV instructions, the addressing mode specified in the instruction can differ for the source and destination EA. However, the 4-bit Wb (register offset) field is shared by both source and destination (but typically only used by one).

In summary, the following addressing modes are supported by move and accumulator instructions:

- Register Direct
- Register Indirect
- Register Indirect Post-modified
- Register Indirect Pre-modified
- Register Indirect with Register Offset (Indexed)
- Register Indirect with Literal Offset
- 8-bit Literal
- 16-bit Literal

Note: Not all instructions support all the addressing modes given above. Individual instructions may support different subsets of these addressing modes.

4.3.4 MAC INSTRUCTIONS

The dual source operand DSP instructions (CLR, ED, EDAC, MAC, MPY, MPY.N, MOVSAC and MSC), also referred to as MAC instructions, use a simplified set of addressing modes to allow the user application to effectively manipulate the Data Pointers through register indirect tables.

The two-source operand prefetch registers must be members of the set {W8, W9, W10, W11}. For data reads, W8 and W9 are always directed to the X RAGU, and W10 and W11 are always directed to the Y AGU. The Effective Addresses generated (before and after modification) must, therefore, be valid addresses within X data space for W8 and W9 and Y data space for W10 and W11.

Note: Register Indirect with Register Offset Addressing mode is available only for W9 (in X space) and W11 (in Y space).

In summary, the following addressing modes are supported by the MAC class of instructions:

- Register Indirect
- Register Indirect Post-Modified by 2
- Register Indirect Post-Modified by 4
- Register Indirect Post-Modified by 6
- Register Indirect with Register Offset (Indexed)

4.3.5 OTHER INSTRUCTIONS

Besides the addressing modes outlined previously, some instructions use literal constants of various sizes. For example, BRA (branch) instructions use 16-bit signed literals to specify the branch destination directly, whereas the DISI instruction uses a 14-bit unsigned literal field. In some instructions, such as ADD Acc, the source of an operand or result is implied by the opcode itself. Certain operations, such as NOP, do not have any operands.

REGISTER 9-2: PMD2: PERIPHERAL MODULE DISABLE CONTROL REGISTER 2

U-0	U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0
—	—	—	—	—	—	IC2MD	IC1MD
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0
—	—	—	—	—	—	OC2MD	OC1MD
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15-10 **Unimplemented:** Read as ‘0’

bit 9 **IC2MD**: Input Capture 2 Module Disable bit
1 = Input Capture 2 module is disabled
0 = Input Capture 2 module is enabled

bit 8 **IC1MD**: Input Capture 1 Module Disable bit
1 = Input Capture 1 module is disabled
0 = Input Capture 1 module is enabled

bit 7-2 **Unimplemented:** Read as ‘0’

bit 1 **OC2MD**: Output Compare 2 Module Disable bit
1 = Output Compare 2 module is disabled
0 = Output Compare 2 module is enabled

bit 0 **OC1MD**: Output Compare 1 Module Disable bit
1 = Output Compare 1 module is disabled
0 = Output Compare 1 module is enabled

TABLE 10-1: SELECTABLE INPUT SOURCES (MAPS INPUT TO FUNCTION)

Input Name	Function Name	Register	Configuration Bits
External Interrupt 1	INT1	RPINR0	INT1R<5:0>
External Interrupt 2	INT2	RPINR1	INT2R<5:0>
Timer1 External Clock	T1CK	RPINR2	T1CKR<5:0>
Timer2 External Clock	T2CK	RPINR3	T2CKR<5:0>
Timer3 External Clock	T3CK	RPINR3	T3CKR<5:0>
Input Capture 1	IC1	RPINR7	IC1R<5:0>
Input Capture 2	IC2	RPINR7	IC2R<5:0>
Output Compare Fault A	OCFA	RPINR11	OCFAR<5:0>
UART1 Receive	U1RX	RPINR18	U1RXR<5:0>
UART1 Clear-to-Send	$\overline{\text{U1CTS}}$	RPINR18	U1CTSR<5:0>
SPI Data Input 1	SDI1	RPINR20	SDI1R<5:0>
SPI Clock Input 1	SCK1	RPINR20	SCK1R<5:0>
SPI Slave Select Input 1	$\overline{\text{SS1}}$	RPINR21	SS1R<5:0>
PWM Fault Input PWM1	FLT1	RPINR29	FLT1R<5:0>
PWM Fault Input PWM2	FLT2	RPINR30	FLT2R<5:0>
PWM Fault Input PWM3	FLT3	RPINR30	FLT3R<5:0>
PWM Fault Input PWM4	FLT4	RPINR31	FLT4R<5:0>
PWM Fault Input PWM5	FLT5	RPINR31	FLT5R<5:0>
PWM Fault Input PWM6	FLT6	RPINR32	FLT6R<5:0>
PWM Fault Input PWM7	FLT7	RPINR32	FLT7R<5:0>
PWM Fault Input PWM8	FLT8	RPINR33	FLT8R<5:0>
External Synchronization signal to PWM Master Time Base	SYNCI1	RPINR33	SYNCI1R<5:0>
External Synchronization signal to PWM Master Time Base	SYNCI2	RPINR34	SYNCI2R<5:0>

REGISTER 10-6: RPINR18: PERIPHERAL PIN SELECT INPUT REGISTER 18

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	U1CTSR5	U1CTSR4	U1CTSR3	U1CTSR2	U1CTSR1	U1CTSR0
bit 15							bit 8

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	U1RXR5	U1RXR4	U1RXR3	U1RXR2	U1RXR1	U1RXR0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15-14 **Unimplemented:** Read as ‘0’

bit 13-8 **U1CTSR<5:0>:** Assign UART1 Clear-to-Send ($\overline{\text{U1CTS}}$) to the Corresponding RPn Pin bits

111111 = Input tied to Vss
100011 = Input tied to RP35
100010 = Input tied to RP34
100001 = Input tied to RP33
100000 = Input tied to RP32
•
•
•
00000 = Input tied to RP0

bit 7-6 **Unimplemented:** Read as ‘0’

bit 5-0 **U1RXR<5:0>:** Assign UART1 Receive (U1RX) to the Corresponding RPn Pin bits

111111 = Input tied to Vss
100011 = Input tied to RP35
100010 = Input tied to RP34
100001 = Input tied to RP33
100000 = Input tied to RP32
•
•
•
00000 = Input tied to RP0

NOTES:

REGISTER 17-1: I2CxCON: I2Cx CONTROL REGISTER (CONTINUED)

bit 5 **ACKDT:** Acknowledge Data bit (when operating as I^2C master, applicable during master receive)
Value that is transmitted when the software initiates an Acknowledge sequence.
1 = Sends NACK during Acknowledge
0 = Sends ACK during Acknowledge

bit 4 **ACKEN:** Acknowledge Sequence Enable bit
(when operating as I^2C master, applicable during master receive)
1 = Initiates Acknowledge sequence on SDAx and SCLx pins and transmits the ACKDT data bit. Hardware is clear at end of master Acknowledge sequence.
0 = Acknowledge sequence is not in progress

bit 3 **RCEN:** Receive Enable bit (when operating as I^2C master)
1 = Enables Receive mode for I^2C. Hardware is clear at end of eighth bit of master receive data byte.
0 = Receive sequence is not in progress

bit 2 **PEN:** Stop Condition Enable bit (when operating as I^2C master)
1 = Initiates Stop condition on SDAx and SCLx pins. Hardware is clear at end of master Stop sequence.
0 = Stop condition is not in progress

bit 1 **RSEN:** Repeated Start Condition Enable bit (when operating as I^2C master)
1 = Initiates Repeated Start condition on SDAx and SCLx pins. Hardware is clear at end of master Repeated Start sequence.
0 = Repeated Start condition is not in progress

bit 0 **SEN:** Start Condition Enable bit (when operating as I^2C master)
1 = Initiates Start condition on SDAx and SCLx pins. Hardware is clear at end of master Start sequence.
0 = Start condition is not in progress

19.0 HIGH-SPEED 10-BIT ANALOG-TO-DIGITAL CONVERTER (ADC)

Note 1: This data sheet summarizes the features of the dsPIC33FJ06GS101/X02 and dsPIC33FJ16GSX02/X04 families of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **"High-Speed 10-Bit Analog-to-Digital Converter (ADC)"** (DS70000321) in the *"dsPIC33/PIC24 Family Reference Manual"*, which is available on the Microchip web site (www.microchip.com).

2: Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 "Memory Organization"** in this data sheet for device-specific register and bit information.

dsPIC33FJ06GS101/X02 and dsPIC33FJ16GSX02/X04 devices provide high-speed, successive approximation Analog-to-Digital conversions to support applications, such as AC/DC and DC/DC power converters.

19.1 Features Overview

The ADC module comprises the following features:

- 10-bit resolution
- Unipolar inputs
- Up to two Successive Approximation Registers (SARs)
- Up to 12 external input channels
- Up to two internal analog inputs
- Dedicated result register for each analog input
- ±1 LSB accuracy at 3.3V
- Single supply operation
- 4 Msps conversion rate at 3.3V (devices with two SARs)
- 2 Msps conversion rate at 3.3V (devices with one SAR)
- Low-power CMOS technology

19.2 Module Description

This ADC module is designed for applications that require low latency between the request for conversion and the resultant output data. Typical applications include:

- AC/DC power supplies
- DC/DC Converters
- Power Factor Correction (PFC)

This ADC works with the high-speed PWM module in power control applications that require high-frequency control loops. This module can sample and convert two analog inputs in a 0.5 microsecond when two SARs are used. This small conversion delay reduces the "phase lag" between measurement and control system response.

Up to five inputs may be sampled at a time (four inputs from the dedicated Sample-and-Hold circuits and one from the shared Sample-and-Hold circuit). If multiple inputs request conversion, the ADC will convert them in a sequential manner, starting with the lowest order input.

This ADC design provides each pair of analog inputs (AN1, AN0), (AN3, AN2),..., the ability to specify its own trigger source out of a maximum of sixteen different trigger sources. This capability allows this ADC to sample and convert analog inputs that are associated with PWM generators operating on Independent Time Bases (ITBs).

The user application typically requires synchronization between analog data sampling and PWM output to the application circuit. The very high-speed operation of this ADC module allows "data on demand".

In addition, several hardware features have been added to the peripheral interface to improve real-time performance in a typical DSP-based application.

- Result alignment options
- Automated sampling
- External conversion start control
- Two internal inputs to monitor the INTREF internal reference and the EXTREF input signal

19.3 Module Functionality

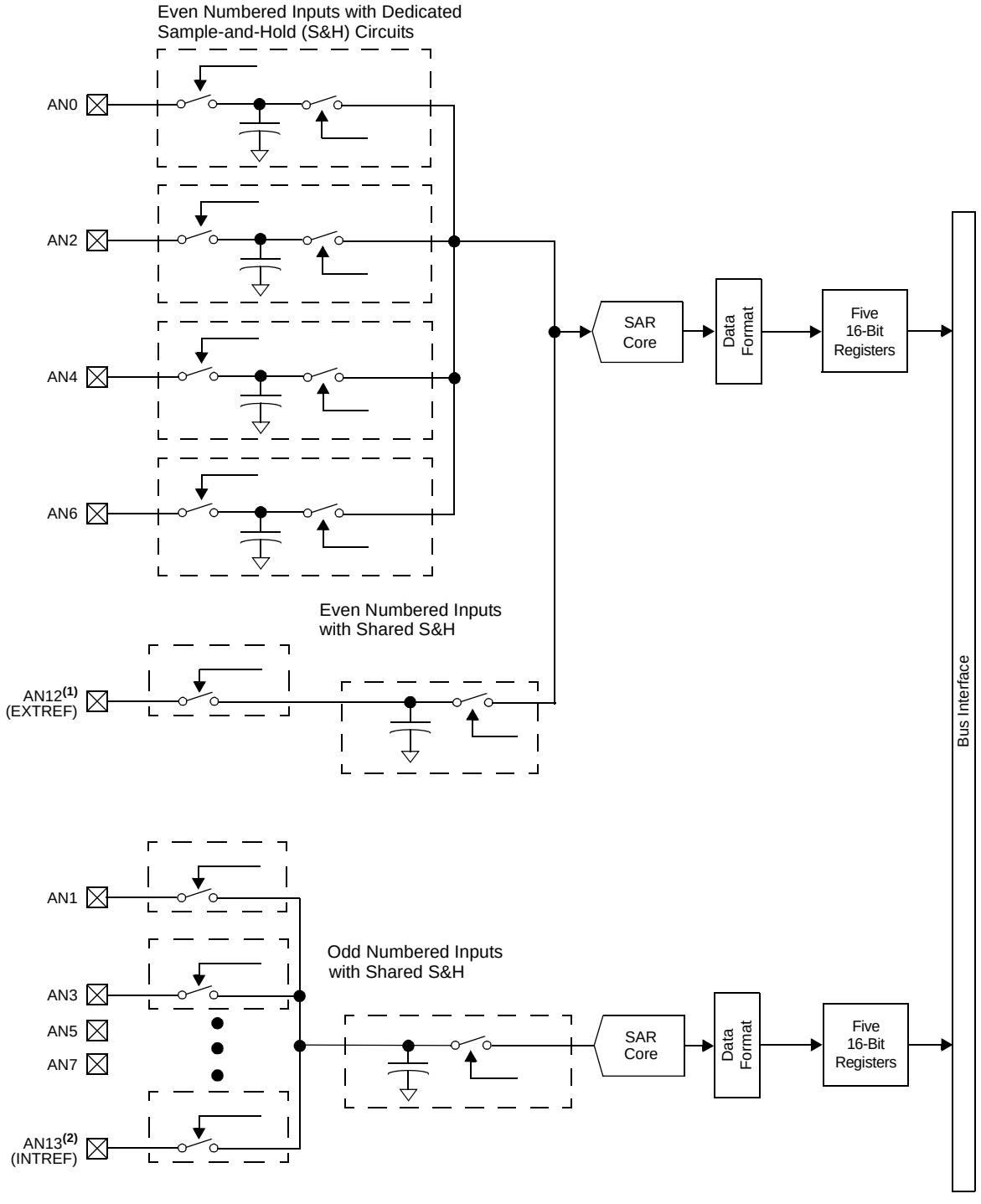
The high-speed, 10-bit ADC module is designed to support power conversion applications when used with the high-speed PWM module. The ADC may have one or two SAR modules, depending on the device variant. If two SARs are present on a device, two conversions can be processed at a time, yielding 4 Msps conversion rate. If only one SAR is present on a device, only one conversion can be processed at a time, yielding 2 Msps conversion rate. The high-speed 10-bit ADC produces two 10-bit conversion results in a 0.5 microsecond.

The ADC module supports up to 12 external analog inputs and two internal analog inputs. To monitor reference voltage, two internal inputs, AN12 and AN13, are connected to the EXTREF and INTREF voltages, respectively.

The analog reference voltage is defined as the device supply voltage (AV_{DD}/AV_{SS}).

Block diagrams of the ADC module are shown in Figure 19-1 through Figure 19-6.

FIGURE 19-5: ADC BLOCK DIAGRAM FOR dsPIC33FJ16GS502 DEVICES WITH TWO SARS



Note 1: AN12 (EXTREF) is an internal analog input. To measure the voltage at AN12 (EXTREF), an analog comparator must be enabled and EXTREF must be selected as the comparator reference.

2: AN13 (INTREF) is an internal analog input and is not available on a pin.

REGISTER 19-7: ADCPC2: ANALOG-TO-DIGITAL CONVERT PAIR CONTROL REGISTER 2(1)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
IRQEN5	PEND5	SWTRG5	TRGSRC54	TRGSRC53	TRGSRC52	TRGSRC51	TRGSRC50
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
IRQEN4	PEND4	SWTRG4	TRGSRC44	TRGSRC43	TRGSRC42	TRGSRC41	TRGSRC40
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **IRQEN5:** Interrupt Request Enable 5 bit
1 = Enables IRQ generation when requested conversion of Channels AN11 and AN10 is completed
0 = IRQ is not generated

bit 14 **PEND5:** Pending Conversion Status 5 bit
1 = Conversion of Channels AN11 and AN10 is pending; set when selected trigger is asserted
0 = Conversion is complete

bit 13 **SWTRG5:** Software Trigger 5 bit
1 = Starts conversion of AN11 and AN10 (if selected by the TRGSRCx bits)(2)
This bit is automatically cleared by hardware when the PEND5 bit is set.
0 = Conversion has not started

Note 1: This register is only implemented in the dsPIC33FJ16GS504 devices.

2: The trigger source must be set as a global software trigger prior to setting this bit to '1'. If other conversions are in progress, then the conversion will be performed when the conversion resources are available.

REGISTER 19-8: ADCPC3: ANALOG-TO-DIGITAL CONVERT PAIR CONTROL REGISTER 3(1)

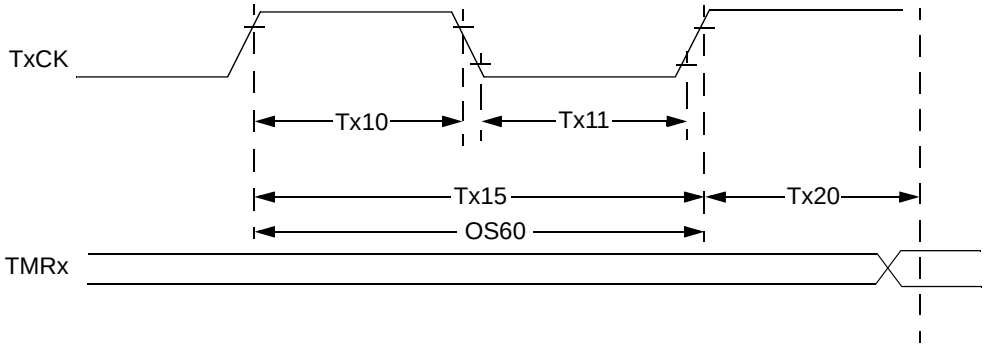
bit 4-0 **TRGSRC6<4:0>:** Trigger 6 Source Selection bits

Selects trigger source for conversion of Analog Channels AN13 and AN12.
11111 = Timer2 period match
•
•
•
11011 = Reserved
11010 = PWM Generator 4 current-limit ADC trigger
11001 = PWM Generator 3 current-limit ADC trigger
11000 = PWM Generator 2 current-limit ADC trigger
10111 = PWM Generator 1 current-limit ADC trigger
10110 = Reserved
•
•
•
10010 = Reserved
10001 = PWM Generator 4 secondary trigger is selected
10000 = PWM Generator 3 secondary trigger is selected
01111 = PWM Generator 2 secondary trigger is selected
01110 = PWM Generator 1 secondary trigger is selected
01101 = Reserved
01100 = Timer1 period match
•
•
•
01000 = Reserved
00111 = PWM Generator 4 primary trigger is selected
00110 = PWM Generator 3 primary trigger is selected
00101 = PWM Generator 2 primary trigger is selected
00100 = PWM Generator 1 primary trigger is selected
00011 = PWM Special Event Trigger is selected
00010 = Global software trigger is selected
00001 = Individual software trigger is selected
00000 = No conversion is enabled

Note 1: This register is only implemented on the dsPIC33FJ16GS502 and dsPIC33FJ16GS504 devices.

2: The trigger source must be set as global software trigger prior to setting this bit to '1'. If other conversions are in progress, conversion will be performed when the conversion resources are available.

FIGURE 24-5: TIMER1, 2 AND 3 EXTERNAL CLOCK TIMING CHARACTERISTICS



Note: Refer to Figure 24-1 for load conditions.

TABLE 24-23: TIMER1 EXTERNAL CLOCK TIMING REQUIREMENTS(1)

AC CHARACTERISTICS				Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param No.	**Symbol**	**Characteristic**		**Min.**	**Typ.**	**Max.**	**Units**	**Conditions**
TA10	TTXH	T1CK High Time	Synchronous, no prescaler	TCY + 20	—	—	ns	Must also meet Parameter TA15, N = Prescale value (1, 8, 64, 256)
			Synchronous, with prescaler	(TCY + 20)/N	—	—	ns	
			Asynchronous	20	—	—	ns	
TA11	TTXL	T1CK Low Time	Synchronous, no prescaler	TCY + 20	—	—	ns	Must also meet Parameter TA15, N = Prescale value (1, 8, 64, 256)
			Synchronous, with prescaler	(TCY + 20)/N	—	—	ns	
			Asynchronous	20	—	—	ns	
TA15	TTXP	T1CK Input Period	Synchronous, no prescaler	2 TCY + 40	—	—	ns	
			Synchronous, with prescaler	Greater of: 40 ns or (2 TCY + 40)/N	—	—	—	N = Prescale value (1, 8, 64, 256)
			Asynchronous	40	—	—	ns	
OS60	FT1	T1CK Oscillator Input Frequency Range (oscillator enabled by setting bit, TCS (T1CON<1>))		DC	—	50	kHz	
TA20	TCKEXTMRL	Delay from External T1CK Clock Edge to Timer Increment		0.75 TCY + 40	—	1.75 TCY + 40	—	

Note 1: Timer1 is a Type A timer.

26.0 50 MIPS ELECTRICAL CHARACTERISTICS

This section provides an overview of dsPIC33FJ06GS101/X02 and dsPIC33FJ16GSX02/X04 electrical characteristics for devices operating at 50 MIPS.

The specifications for 50 MIPS are identical to those shown in **Section 24.0 "Electrical Characteristics"**, with the exception of the parameters listed in this section.

Parameters in this section begin with the letter "M", which denotes 50 MIPS operation. For example, Parameter DC29a in **Section 24.0 "Electrical Characteristics"**, is the up to 40 MIPS operation equivalent of MDC29a.

Absolute maximum ratings for the dsPIC33FJ06GS101/X02 and dsPIC33FJ16GSX02/X04 50 MIPS devices are listed below. Exposure to these maximum rating conditions for extended periods can affect device reliability. Functional operation of the device at these or any other conditions above the parameters indicated in the operation listings of this specification is not implied.

Absolute Maximum Ratings(1)

Ambient temperature under bias ..... -40°C to +85°C
Storage temperature ..... -65°C to +150°C
Voltage on V_{DD} with respect to V_{SS} ..... -0.3V to +4.0V
Voltage on any pin that is not 5V tolerant, with respect to V_{SS}(3) ..... -0.3V to (V_{DD} + 0.3V)
Voltage on any 5V tolerant pin with respect to V_{SS}, when Vdd ≥ 3.0V(3) ..... -0.3V to +5.6V
Voltage on any 5V tolerant pin with respect to Vss, when V_{DD} < 3.0V(3) ..... -0.3V to (V_{DD} + 0.3V)
Maximum current out of V_{SS} pin ..... 300 mA
Maximum current into V_{DD} pin(2) ..... 250 mA
Maximum current sourced/sunk by any 4x I/O pin ..... 15 mA
Maximum current sourced/sunk by any 8x I/O pin ..... 25 mA
Maximum current sourced/sunk by any 16x I/O pin ..... 45 mA
Maximum current sunk by all ports ..... 200 mA
Maximum current sourced by all ports(2) ..... 200 mA

Note 1: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

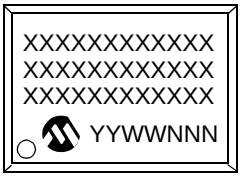
2: Maximum allowable current is a function of device maximum power dissipation (see Table 24-2).

3: See the **"Pin Diagrams"** section for 5V tolerant pins.

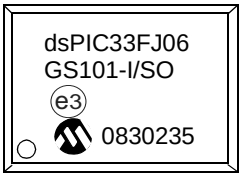
28.0 PACKAGING INFORMATION

28.1 Package Marking Information

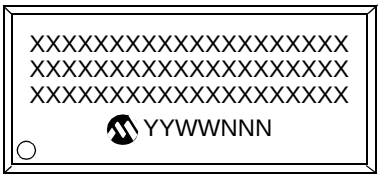
18-Lead SOIC (.300”)



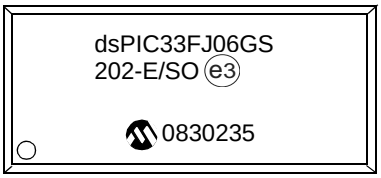
Example



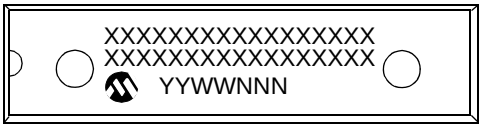
28-Lead SOIC



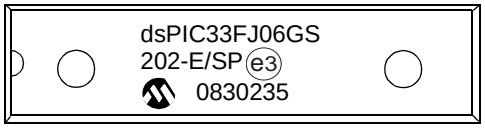
Example



28-Lead SPDIP



Example



28-Lead QFN-S

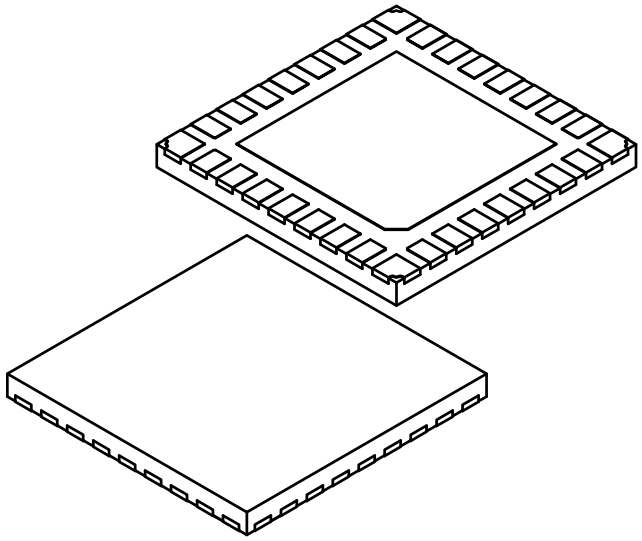
Example

Legend:	XX...X	Customer-specific information
	Y	Year code (last digit of calendar year)
	YY	Year code (last 2 digits of calendar year)
	WW	Week code (week of January 1 is week ‘01’)
	NNN	Alphanumeric traceability code
	(e3)	Pb-free JEDEC designator for Matte Tin (Sn)
	*	This package is Pb-free. The Pb-free JEDEC designator ((e3)) can be found on the outer packaging for this package.

Note: If the full Microchip part number cannot be marked on one line, it is carried over to the next line, thus limiting the number of available characters for customer-specific information.

28-Lead Plastic Quad Flat, No Lead Package (MX) - 6x6x0.5mm Body [UQFN] Ultra-Thin with 0.40 x 0.60 mm Terminal Width/Length and Corner Anchors

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N		28	
Pitch	e		0.65 BSC	
Overall Height	A	0.40	0.50	0.60
Standoff	A1	0.00	0.02	0.05
Terminal Thickness	(A3)		0.127 REF	
Overall Width	E		6.00 BSC	
Exposed Pad Width	E2		4.00	
Overall Length	D		6.00 BSC	
Exposed Pad Length	D2		4.00	
Terminal Width	b	0.35	0.40	0.45
Corner Pad	b2	0.25	0.40	0.45
Terminal Length	L	0.55	0.60	0.65
Terminal-to-Exposed Pad	K	0.20	-	-

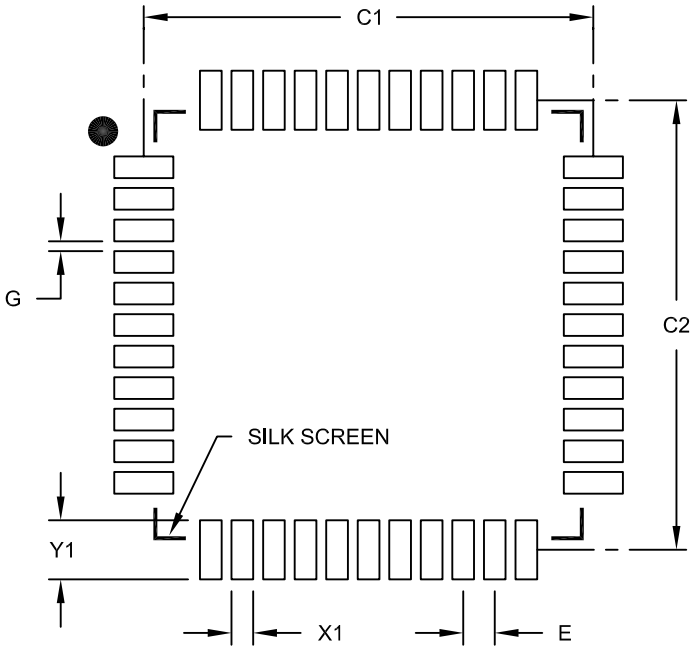
Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Package is saw singulated
3. Dimensioning and tolerancing per ASME Y14.5M
   BSC: Basic Dimension. Theoretically exact value shown without tolerances.
   REF: Reference Dimension, usually without tolerance, for information purposes only.
4. Outermost portions of corner structures may vary slightly.

Microchip Technology Drawing C04-0209B Sheet 2 of 2

44-Lead Plastic Thin Quad Flatpack (PT) 10X10X1 mm Body, 2.00 mm Footprint [TQFP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E		0.80 BSC	
Contact Pad Spacing	C1		11.40	
Contact Pad Spacing	C2		11.40	
Contact Pad Width (X44)	X1			0.55
Contact Pad Length (X44)	Y1			1.50
Distance Between Pads	G	0.25		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2076B